SMD Reflective Optical Sensor

OPB9000

Features

- Market leading 25k+ lux ambient light immunity
- Programmable output configuration and sensitivity level
- Single-command calibration with on-chip EEPROM
- Temperature-compensated LED drive
- 6µs response time
- Pulsed synchronous drive-detection
- Surface mount package
- Small dimensions: L 4.0mm x W 2.2mm x H 1.46mm
- -40°C to +85°C operating temperature range
- 2.7V to 5.5V supply voltage
- Ideal for industrial and medical applications



Description

The OPB9000 is a versatile sensor that can be used in a wide variety of industrial and medical applications. The sensor features market-leading ambient light immunity which allows operation from dark rooms to bright sunlight. It can detect various types of media with as little as a 30% change in reflectivity. Robust, industrial grade resin allows the sensor to operate at a wide temperature range from -40C to + 85C, ideal for the harshest environments.

Factory calibrated to a white card at a 12mm distance to offer plug and play detection, the OPB9000 can be re-calibrated in a matter of milliseconds with a single command for specific application requirements. Integrated automatic temperature compensation maximizes detection consistency and reliability. The small footprint saves valuable PCB real estate as devices become smaller and more portable.

The OPB9000 eliminates the need for peripheral circuitry like op-amps, data converters, and comparators, as all analog signal conditioning is integrated in the IC.

Applications

- All non-contact position sensing and presence detecting applications
- Industrial printing and high-speed paper detection
- Manufacturing and automation
- Automated banking machines
- Hospital and lab equipment
- Portable medical equipment
- Automatic dispensing
- Material handling and asset tracking

Pb-Free (RoHS)

ESD (Human Body Model)

MOISTURE (Level-4)

Ordering Information

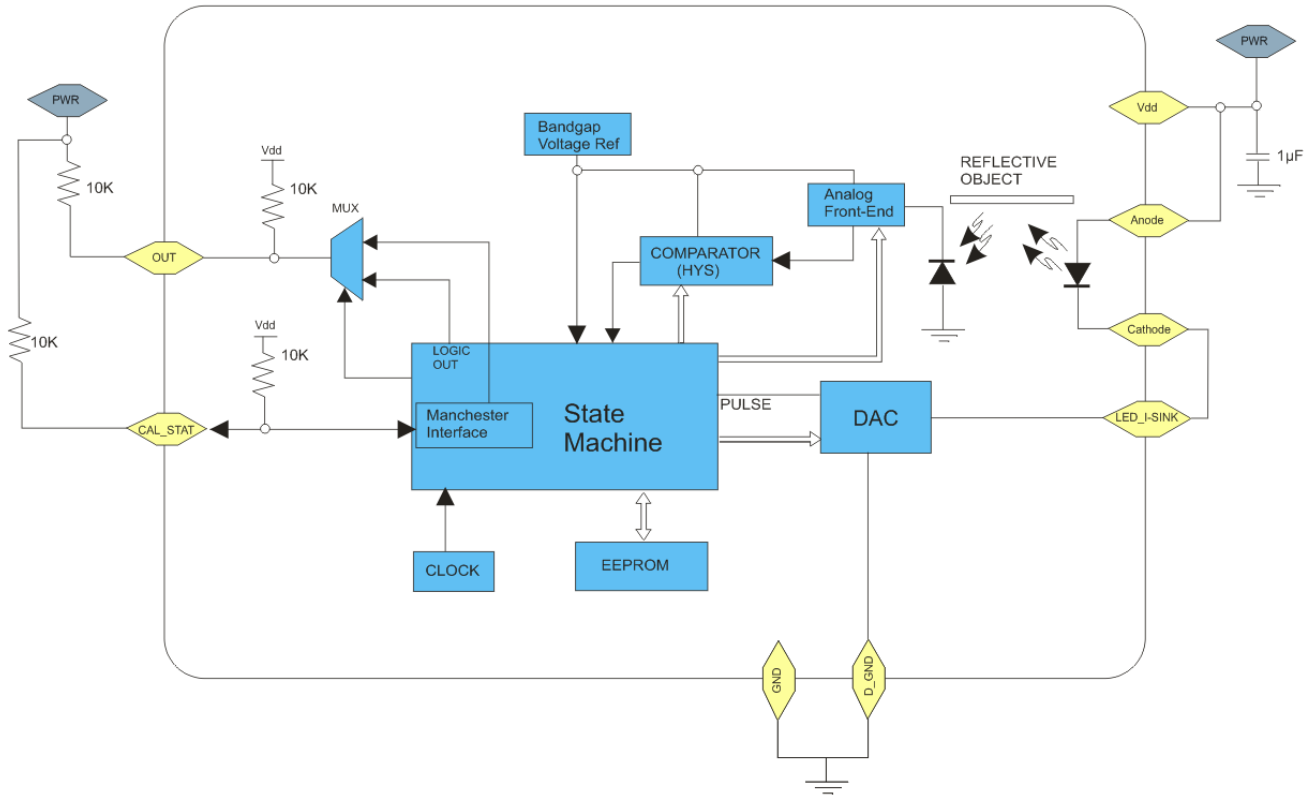
Part Number	Packaging	Quantity
OPB9000	Tape and reel	2500 per reel

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Recommended Application Circuit



Pin	Name	Function/Description
1	V_{DD}	Positive supply power input
2	D_GND	Digital ground—connect to ground
3	GND	Ground—connect to D_GND
4	ANODE	LED anode—connect to VDD
5	CATHODE	LED cathode (connect to LED I-SINK pin)
6	LED I-SINK	LED current sink (connect to LED cathode)
7	CAL_STAT	Calibrate input / status output (to verify successful calibration)
8	OUT	Logic output, also used as digital output to read register bits

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Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)			
Parameter	**Symbol**	**Maximum**	**Units**
DC supply voltage	V_{DD}	6	V
Voltage on any pin with respect to GND		-0.5, +6	V
Voltage on any pin with respect to V_{DD}		-6, +0.5	V
Current into or out of any pin other than GND, cathode		±20	mA
Current into or out of GND, cathode		±150	mA
Illuminance / background light	I_X	25	kLux
ESD immunity (human body model)	ESD	±2 HBM; contact discharge	kV
Operating temperature range	T_{OPR}	-40°C to +85°C	
Storage temperature range	T_{STG}	-40°C to +105°C	

Note: Permanent damage to the device may occur if operated outside the Absolute Maximum specifications. Proper function and reliability of the device at these or any other conditions outside the Recommended Operating Conditions may also be adversely affected

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Electrical Specifications (cont.)

Electrical Characteristics (T_A = 25° C unless otherwise noted)

SUPPLY CHARACTERISTICS

#	PARAMETER	SYM	CONDITIONS	MIN	NOM	MAX	UNIT	NOTES
1	Supply voltage	V_{DD}		2.7		5.5	V	
2	Supply current—active	I_{DDA}	[OP,DS] = 'b01; [CA] = 'b1			4.2	mA	1
3	Supply current (including LED drive)	I_{DD}	[OP,DS] = 'b01; [CA] = 'b1			16	mA	
4	Supply voltage ripple immunity	ΔV_{DDpp}	Sinusoidal; f ≤ 10 kHz	.02 * V_{DD}			V	16
5	Wake-up time	t_{WU}				32	ms	2

LED I-SINK PIN CHARACTERISTICS

#	PARAMETER	SYM	CONDITIONS	MIN	NOM	MAX	UNIT	NOTES
6	LED pulsed drive current	$I_{OL:K:max}$	Maximum [LED] value; VDD—V(K) ≤ 2V		85		mA	
7	LED pulsed drive current	$I_{OL:K:min}$	Minimum [LED] value; VDD—V(K) ≤ 2V		3		mA	
8	LED pulse period	t_{PER}			2		µs	
9	LED pulse duty cycle	DC_{PW}			12.5%			
10	LED pulse settling time	$t_{S:K}$				100	ns	3

OUT PIN CHARACTERISTICS

#	PARAMETER	SYM	CONDITIONS	MIN	NOM	MAX	UNIT	NOTES
11	Output low voltage (OUT pin)	$V_{OL:OUT}$	I_{OL} = 4mA; [OP,DS] = 'b01; [CA] = 'b1; photodiode DARK			0.4	V	
12	Output high voltage (OUT pin)	$V_{OH:OUT}$	I_{OH} = -4mA; [OP,DS] = 'b11; [CA] = 'b1; photodiode DARK	V_{DD}—1			V	
13	Leakage current (OUT pin)	$I_{L:OUT}$	[OP,DS] = 'b10; [CA] = 'b1; V(OUT) = V_{DD} = 5.5V; photodiode DARK			1	µA	
14	Pullup resistance (OUT pin)	$R_{P:OUT}$	[OP,DS] = 'b10; [CA] = 'b1; V(OUT) = 0; photodiode DARK	6.1		19.1	kΩ	
15	Read output bit time	t_{ROB}	First two bits to be read are 'b0, 'b1	5		20	µs	4
16	Read output delay time	t_{ROD}	[OP,DS] = 'b10; [CA] = 'b1; photodiode DARK; LSB to be read is 'b1			6	µs	5
17	Optical response time	t_{OR}			6	6.5	µs	6

'b0 = [Low]
'b1 = [High]
'b01 = [Low, High]
'b11 = [High, High]
'b10 = [High, Low]

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Electrical Specifications (cont.)

Electrical Characteristics (T_A = 25° C unless otherwise noted)

CAL PIN CHARACTERISTICS

#	PARAMETER	SYM	CONDITIONS	MIN	NOM	MAX	UNIT	NOTES
18	Output low voltage (CAL pin)	$V_{OL:CAL}$	I_{OL} = 4 mA; STATUS or WRITE mode			0.4	V	
19	Leakage current (CAL pin)	$I_{L:CAL}$	OPERATION mode; V(CAL) = VDD = 5.5V			1	µA	
20	Pullup resistance (CAL pin)	$R_{P:CAL}$	OPERATION mode; V(CAL) = 0V	5.5		18.2	kΩ	
21	Input low voltage (CAL pin)	$V_{IL:CAL}$				0.3 *V_{DD}	V	
22	Input high voltage (CAL pin)	$V_{IH:CAL}$		0.7 *V_{DD}			V	
23	Input hysteresis (CAL pin)	$V_{HY:CAL}$		0.1 *V_{DD}			V	
24	Input bit time	t_{IB}		6.35		20	µs	7
25	Input half-bit time	t_{IHB}		0.47 * t_{IB}		0.53 * t_{IB}	µs	8
26	CALIBRATION—mode duration	t_{CAL}		3		17	ms	9
27	STATUS—mode duration	t_{STAT}		10	13.5	16	ms	10
28	WRITE/READ—mode delay	t_{WRD}				1	µs	11
29	WRITE—mode duration	t_{WR}				19	ms	12
30	READ—mode duration	t_{RD}				465	µs	13

OPTICAL CHARACTERISTICS

#	PARAMETER	SYM	CONDITIONS	MIN	NOM	MAX	UNIT	NOTES
31	Minimum positive going threshold irradiance (DARK → LIGHT)	$E_{eT(+)}$	[REF] = 0; [CA] = ‘b1; no ambient light		0.16		mW/cm²	
32	Maximum positive going threshold irradiance (DARK → LIGHT)	$E_{eT(+)}$	[REF] = 15; [CA] = ‘b1		3.1		mW/cm²	
33	Hysteresis ratio (positive going threshold irradiance / negative going threshold irradiance)	$E_{eT(+)}/E_{eT(-)}$	[CA] = ‘b1; no ambient light	1.1	1.15	1.25	-	
34	Ratio of optical input thresholds at adjacent comparator reference voltage settings	k_{REF}	[CA] = ‘b1; no ambient light		1.075		-	
35	Ambient light immunity	$E_{X(max)}$	5780K black-body radiator; amplitude has no frequency components greater than 10 kHz	25			klux	14
36	Optical input threshold sensitivity to V_{DD}	εv	[CA] = ‘b1; no ambient light			4.5%	V^{-1}	
37	Calibration result spread over temperature	ε_T	Closed system including LED; CA]=‘b1; no ambient light	-25%		25%	-	15

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Electrical Specifications (cont.)

Electrical Characteristics (T_A = 25° C unless otherwise noted)							
NON VOLATILE MEMORY CHARACTERISTICS							
#	**PARAMETER**	**SYM**	**CONDITIONS**	**MIN**	**NOM**	**MAX**	**UNIT**
38	No. of program cycles	$P_{CY(amb)}$	$T_A \leq 25°C$; no ambient light	100K			cy
39	No. of program cycles	$P_{CY(hot)}$	$T_A \leq 105°C$; no ambient light	10K			cy
40	Data retention time	t_{DR}	$-40°C \leq T_A \leq 105°C$; no ambient light	10			yrs

Electrical Characteristics (T_A = 25° C unless otherwise noted)							
LED CHARACTERISTICS							
#	**PARAMETER**	**SYM**	**CONDITIONS**	**MIN**	**NOM**	**MAX**	**UNIT**
41	Peak wavelength	λ_P	I_F = 20 mA		850		nm
42	Forward voltage	V_F	I_F = 20 mA		1.45	1.55	V
43	Reverse voltage	V_R	I_R = 10 µA	5.0			V
44	Optical power	P_O	I_F = 20 mA	3.2			mW
45	Rise time	T_R	I_F = 20 mA		25		ns
46	Fall time	T_F	I_F = 20 mA		13		ns

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Electrical Specifications (cont.)

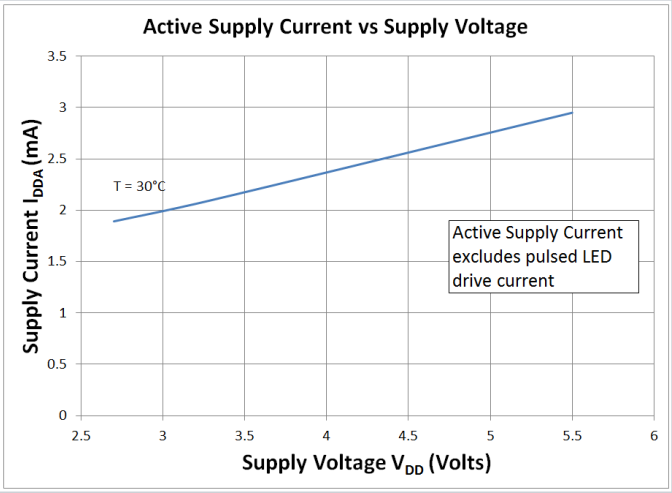
Test Notes

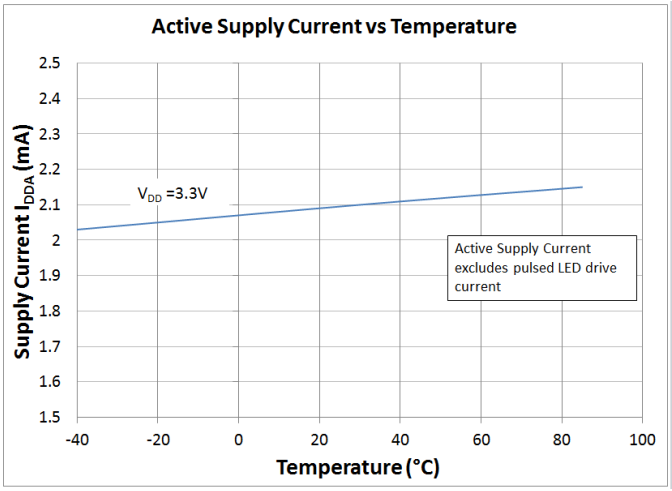
1. Excludes LED pulsed drive current.
2. Time at power-up between VDD settling to within 0.1V of its steady-state level and CAL going high at the end of the SETTLE mode interval.
3. Time from start of pulse to the point at which the pulsed current reaches within ±1% of the final level and remains in that range for the remainder of the pulse.
4. Time from OUT going low at the midpoint of the first bit (‘b0) to OUT going high at the midpoint of the second bit (‘b1); should be equal to 10*tPER(T).
5. Time from CAL going high (indicating completion of internal read command) to OUT going low (start of Manchester-encoded LSB of data being read).
6. Equal to 2 to 3 LED pulse periods.
7. CAL going low and high (for ‘b0 or ‘b1 input bit, respectively) at the time from midpoint of one input bit to CAL going low or high at the midpoint of the next input bit; should be equal to 10*tPER(T).
8. Time from CAL going low or high (for ‘b0 or ‘b1 input bit, respectively) at the midpoint of one input bit to CAL going high or low at the beginning of the next input bit; only applicable if the next input bit is of opposite polarity.
9. Time from CAL going high at the midpoint of the last input bit of the calibration command sequence to CAL going low at the end of a successful calibration; absence of CAL going low within this interval means that the calibration failed.
10. Time from CAL going low at the end of a successful calibration to the subsequent CAL going high.
11. Applicable for read command sequences and for write sequences if the last data input bit is ‘b1: time from CAL going high at the midpoint of the bit (last data input bit for writes, last command-code bit for reads) to the CAL going low following the end of the last data input bit.
12. Time from CAL going low either after the end of the last data input bit of the write command sequence (if that bit is ‘b1) or at the midpoint of that bit (if that bit is ‘b0) to the subsequent CAL going high. Includes any stabilization time required for newly programmed [REF] setting.
13. Time from CAL going low after the end of the last command-code bit of the read command sequence to the subsequent CAL going high.
14. “Immune” = “optical input threshold moves by ≤5%”
15. [(LED resulting from calibration @ T) / (LED resulting from calibration @ 40°C)] - 1.
16. LSL 0.02*VDD for f ≤ 10 kHz, 0.01*VDD for f ≤ 50 kHz, 0.005*VDD for f ≤ 1 mHz.

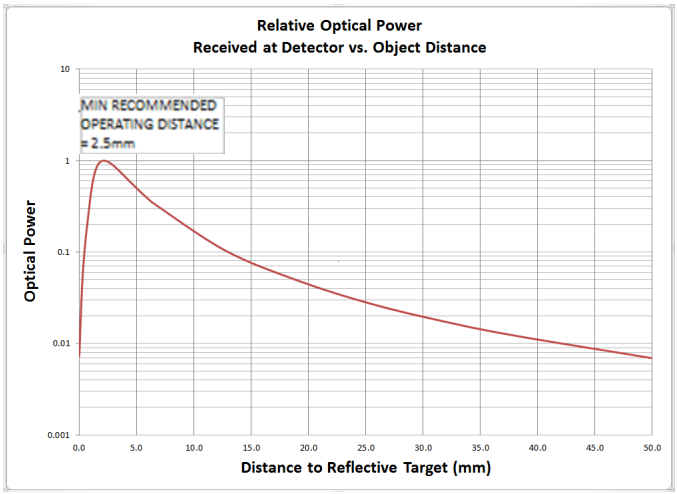
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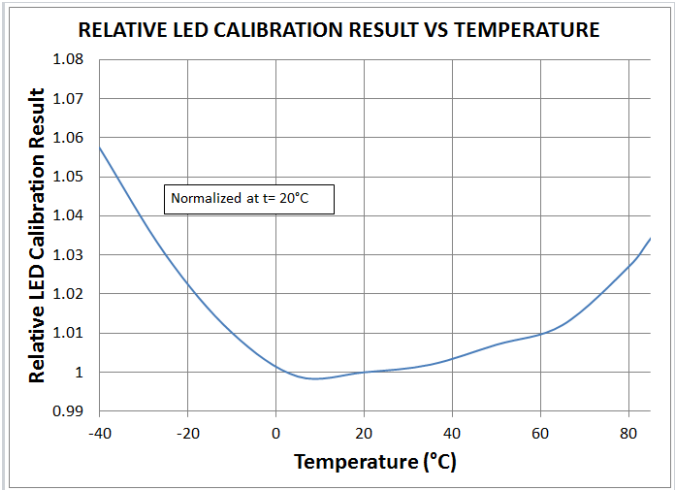
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Typical Characteristics (T_A = 25°C unless noted otherwise)





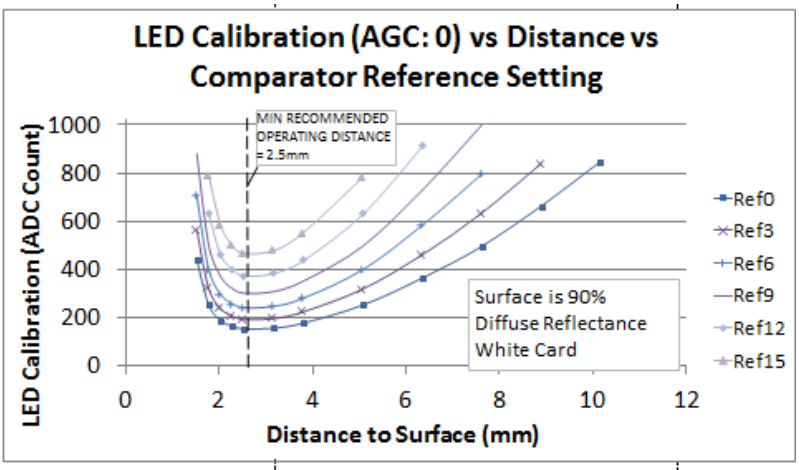


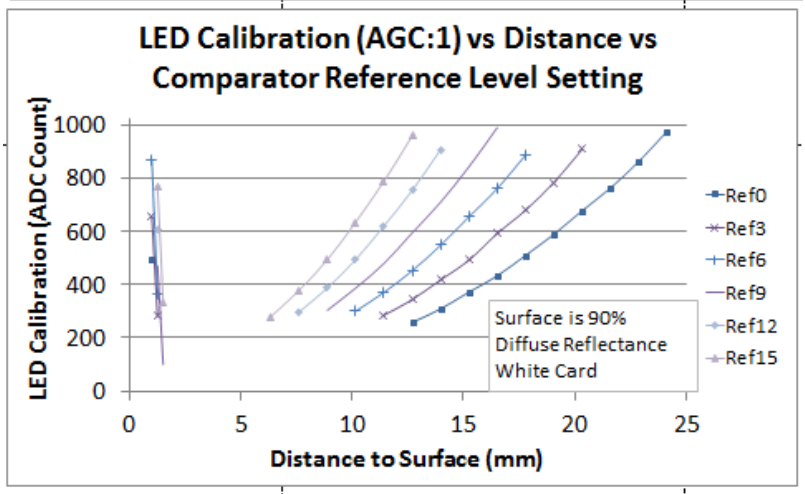


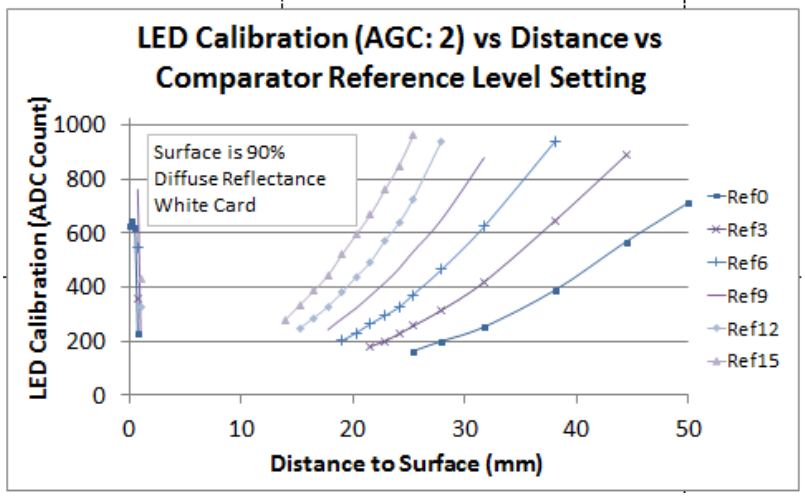
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Typical Characteristics

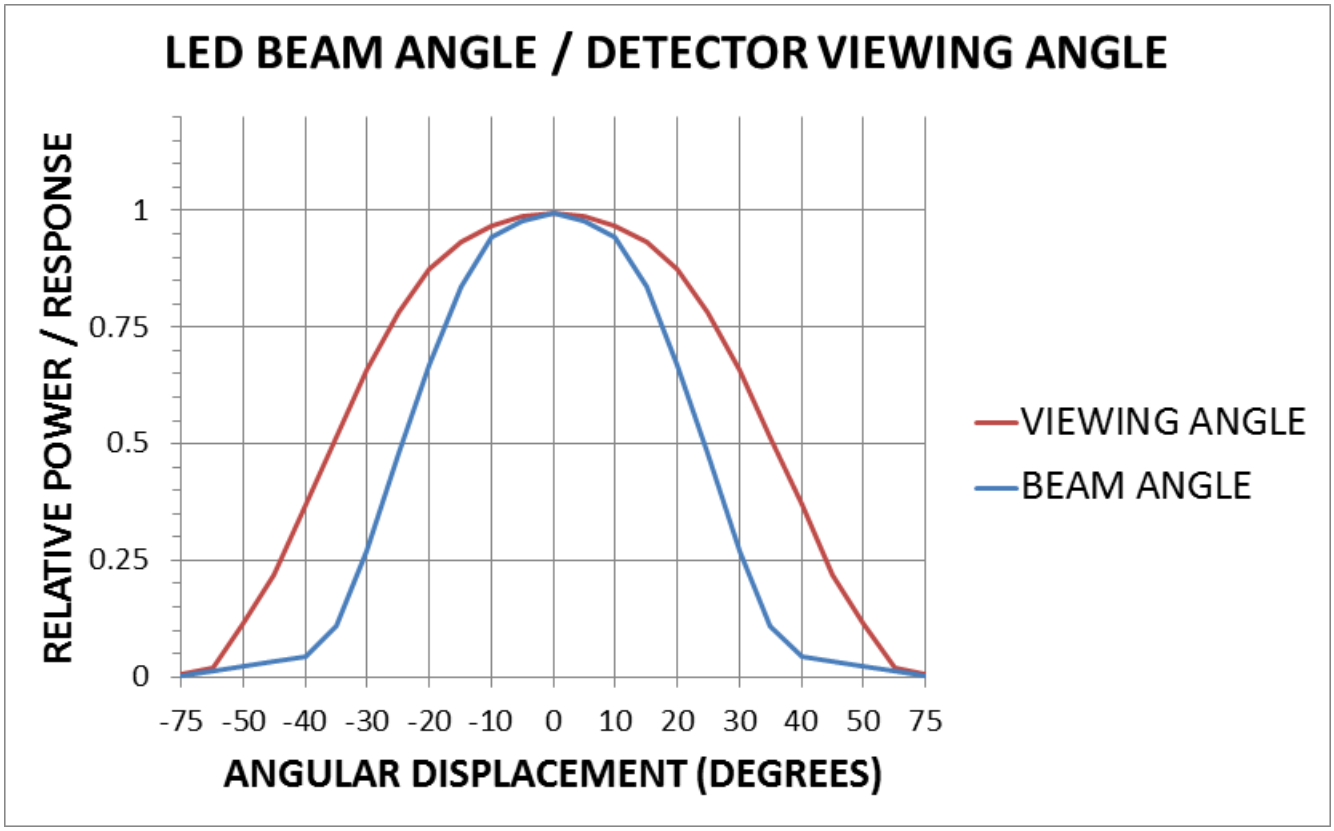






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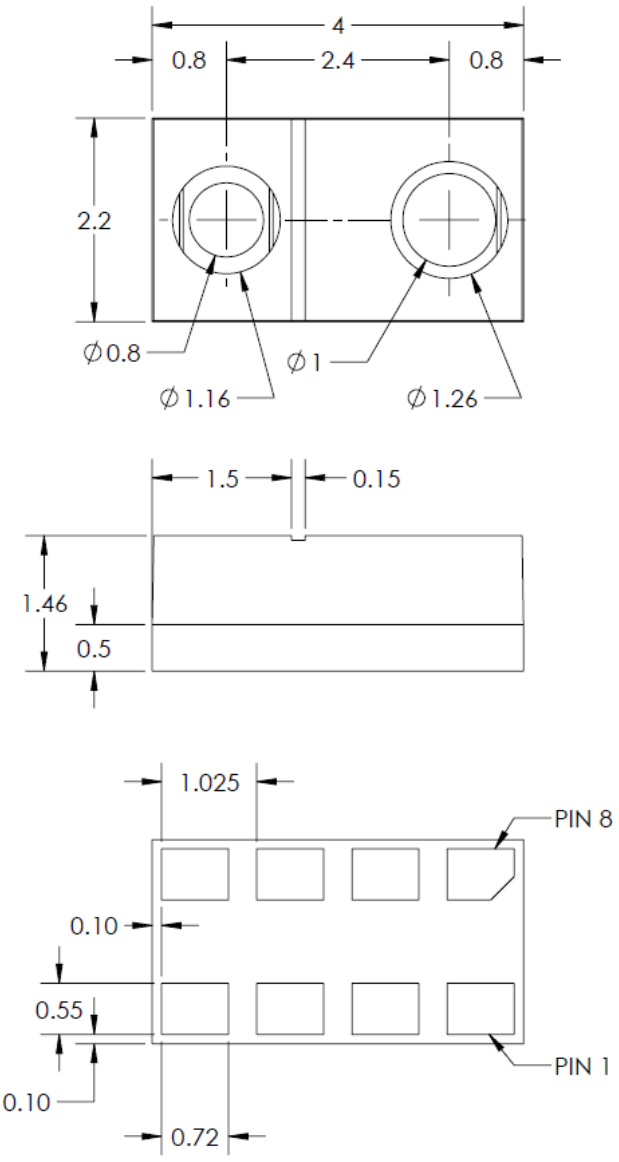
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Package Outline, Pinout, and Function Table



Pin	Function
1	V_{DD}
2	DIGITAL GROUND
3	GROUND
4	ANODE
5	CATHODE
6	LED I-SINK
7	CAL / STATUS
8	OUTPUT

Notes:

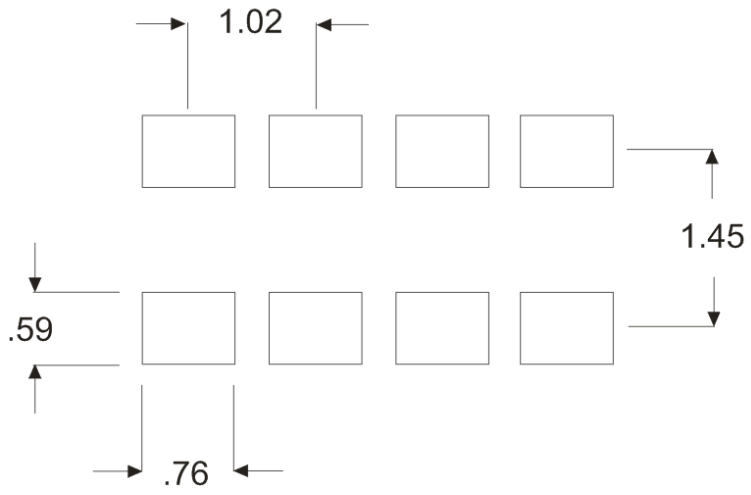
1. Dimensions are in mm.
2. Tolerances are ±0.1.
3. Pad with 45° corner indicates Pin 8.

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Recommended Land Pattern (units are mm)



Detailed Description / Application Information

The OPB9000 is a reflective CMOS sensor with calibration features and programmable sensitivity and output type. The monolithic CMOS receiver/LED driver controls all functional modules of the device, including calibrate/status, read/write, and operate.

The device can be calibrated to detect various reflective surfaces at different distances. An on-chip EEPROM is used to store the calibrated LED drive current level, sensitivity level, and output type, allowing the sensor to return to the correct levels and states upon the next power-up cycle. A brief status mode follows every calibration sequence allowing the user to ensure that the calibration was successful. The LED drive current remains in operation mode until a valid command is received (calibrate, read, or write).

Output types and threshold levels can be programmed as part of the calibration process. The default output type is inverter (signal detected, output low), totem pole (push-pull). The output can be programmed to detect either a decreasing signal level or an increasing signal level, but not both at the same time. The filtered amplifier output is integrated for comparison to a 4 bit programmable threshold voltage and the result determines the device output state. If the amplifier output is above or below the threshold voltage for 2 consecutive LED pulses, the output will switch to the proper state. The actual logic level is dependent upon the output type that has been programmed (table 1).

The OPB9000 includes an on-chip photodiode which feeds a bandpass filtered analog front end amplifier to accomplish ambient light immunity as well as signal amplification. An LED driver pulses the LED for 250ns at a pulse rate of 2us (12.5% duty cycle). The OPB9000 switches states when the reflected signal decreases by approximately 50% from the calibrated level. The device includes temperature compensation over its operating temperature range as well as plastic lensing over both LED and detector to narrow the beam spread/viewing angle and maximize detection distance capability.

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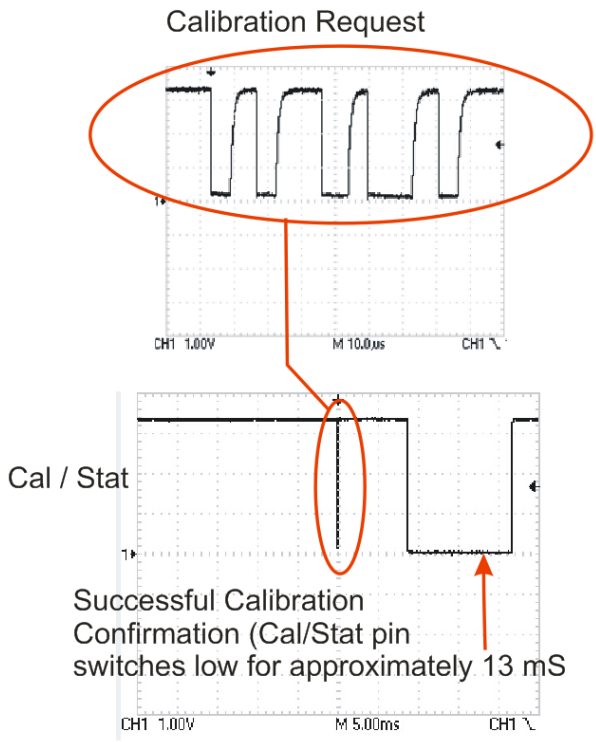
Detailed Description / Application Information

Calibration

The OPB9000 may be programmed to a specific output type and sensitivity level, then self-calibrated against a specific target at a specific distance from the sensor face.

By default, the output is inverted in a push-pull configuration (i.e. output is low when object is detected). The sensitivity level is set for detection of a 90% diffuse reflectance white card at a distance of 12mm, and a change of state when the reflected signal drops by approximately 50%. This default setting is sufficient for use in many applications. The user can re-program and re-calibrate the device for a specific application.

During a calibration process, the pulsed LED drive is ramped from 3 mA to approximately 85 mA (at the above mentioned pulse duration and pulse period) until the reference level is reached for two consecutive pulses. The LED drive current value is then stored in an EEPROM bank. The ramping period is 17mS max; a subsequent STATUS mode is active for an additional 13 mS. After a calibration request is sent, and during the ramping period, the CAL/STAT pin will be in a high state. After the ramping period ends with a successful calibration, the pin will transition to a low state for the STATUS mode (as seen in the screenshot). If the calibration is unsuccessful, then the CAL/STAT pin will remain high for the STATUS mode period. An unsuccessful calibration can occur if no reflective surface is present or insufficient light is received during the process.



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Detailed Description / Application Information

The procedure for calibrating the OPB9000 usually includes sending three commands to the device on the calibrate/status pin. Those commands are as follows:

- Command 1 — send write command to set output type (OP and DS bits, table 1) and comparator reference level bits (table 2)
- Command 2 — send command to calibrate LED drive
- Command 3 — send write command to change comparator to new desired reference level (to adjust detection sensitivity)

Programmable Sensitivity Levels

The sensitivity level is determined by the difference in the reference level settings between Command 1 and Command 3 in the previous section. See table 2 for available reference level settings. Below are a few examples of sensitivity level settings.

- Example 1: A device is programmed to a reference level setting of 2 during the writing of command 1 to the device. This establishes a relatively low trip threshold of approximately 281 mV during the LED calibration step (Command 2), which would normally be needed in cases where the reflected light levels are low, e.g. the target surface has low reflectance and/or the target is far from the device. In cases where the target is more reflective or closer to the sensor, a higher reference level could be selected if desired. In general, the higher the reference level used for the Command 1 write, the higher the LED drive required to calibrate the device. During the writing of Command 3 to the device, the reference level setting is changed from 2 to 0. This establishes the comparator trip level at approximately 245 mV. This level is 87% (245/281) of the level used to calibrate the LED drive. Therefore, an approximate 13% reduction in light level will now cause the output state to change.
- Example 2: A device is again programmed to a reference level setting of 2 during the writing of command 1 to the device. During the writing of Command 3 to the device, the reference level setting is changed to 6, causing an immediate output state change to its pre-calibrated level. Ref level 6 establishes the comparator trip level at approximately 368 mV. This level is 131% (368/281) of the level used to calibrate the LED drive. Therefore, an approximate 31% increase in light level will be required to cause the output state to change.
- Example 3: A device is programmed to a reference level setting of 14 during the writing of Command 1 to the device. During the writing of Command 3 to the device, the reference level setting is changed to 3. This level is 47% (300/632) of the level used to calibrate the LED drive. Therefore, an approximate 53% decrease in light level will be required to cause the output state to change.

EEPROM STRUCTURE

BANK 1 (13 bits) (READ ONLY)

LED drive counts (10 bits)	NOT USED (2 bits)	Calibration successful (1 bit)
LED REF <12:3>	NOT USED <2:1>	CA <0>

BANK 2 (6 bits) (READ/WRITE)

Output type (1 bit)	Drain select (1 bit)	Comparator REF (4 bits)
OP <5>	DS <4>	REF <0:3>

BANK 3 (9 bits RESERVED)

7 RESERVED Bits

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Detailed Description / Application Information

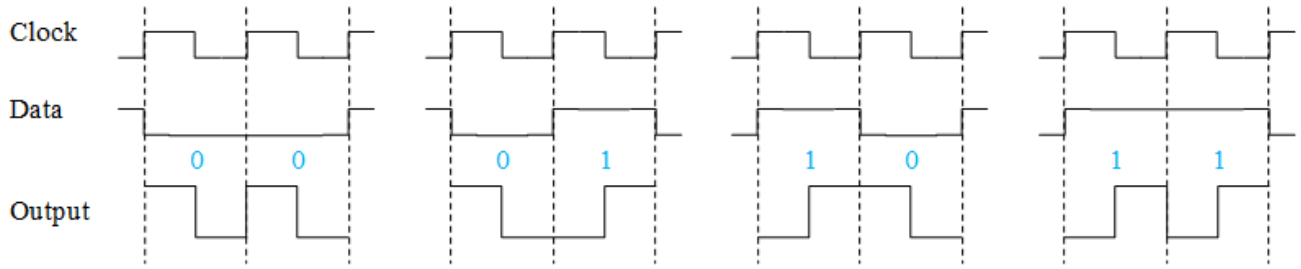
Communication Standard

The Manchester Code follows the standard IEEE 802.3:

- "0" is expressed as a midpoint high-to-low transition, "1" is low-to-high transition
- Encoded output = data XOR clock

The waveform chart below shows the Manchester encoded output for each possible two bit sequence.

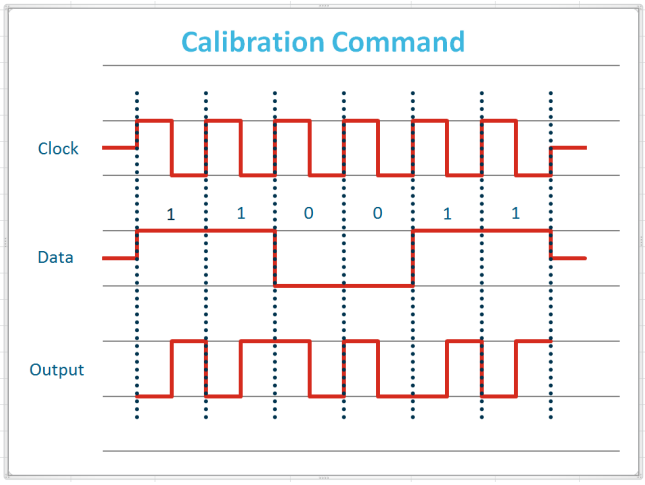
Commands



All commands sent to the OPB9000 are sent via the CAL/STAT pin. Each command must first begin with the syncing nibble (1100). The first two bits "11" allow the decoder to detect the data clock. The second two bits are a check for detection of the "00" data. The third two bits determine the command being sent. The available commands are:

- 1100-00 Reserved (do nothing)
- 1100-01 Read request
- 1100-10-bbbbbb Write Bank 2 bits
- 1100-11 Calibrate request

For a read or calibration request, there will be 6 bits: "1100-01" or "1100-11" respectively:



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Detailed Description / Application Information

Commands (cont.)

For a Write Bank 2 command, there will be a total of 12 bits: “1100-10-bbbbbb”, where the last 6 bits are data to be written to EEPROM. These 6 data bits are defined in table 1 (OP,DS bits) and table 2 (comparator REF bits 0-3). The sequence of transmission of these bank 2 bits must be from most significant to least significant bit—ie. bit 5 to bit 0 (after syncing nibble and two clock detection bits). The data rate for the write command is 100 kb/s [+100 kb/s, -50 kb/s].

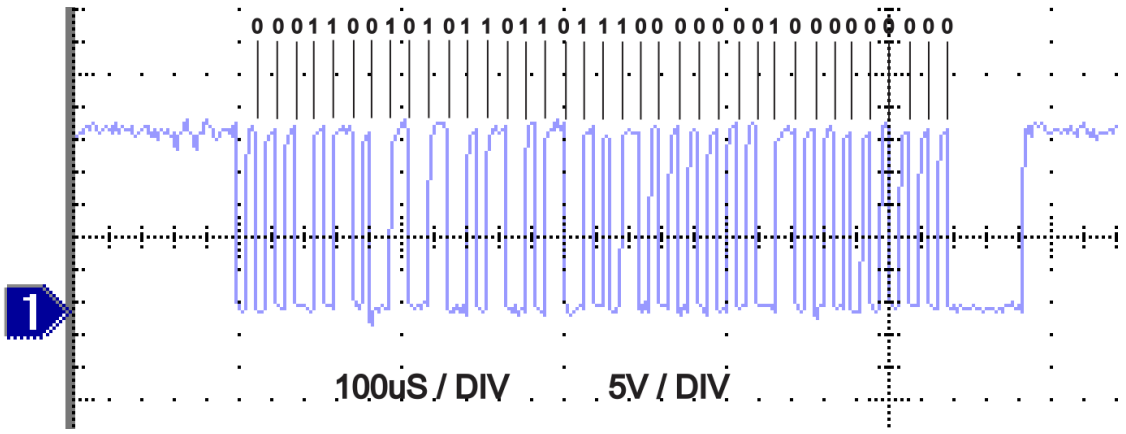
Read Request Data Bit Sequence and Rate

The read request will serially transmit Manchester-encoded data (100 kb/s at 50% duty cycle, ±5 kb/s), from the Vout pin, the EEPROM bank values and also include an error flag. A total of 37 bits will be transmitted including a zero as the first bit and an error flag bit as the 2nd bit. Example is shown in below figure.

			BANK 3 (RESERVED)									BANK 1 (LED COUNT, AGC , & CA BITS)												
	Start Bit	Error Flag	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	CA bit	AGC (LSB)	AGC (MSB)	LED (LSB)	LED	LED	LED	LED	LED	LED	LED	LED	LED (MSB)
Bit Value	0	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X
Bit #	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24
Example	0	0	0	1	1	0	0	1	0	1	0	1	1	0	1	1	0	1	1	1	0	0	0	0

	BANK 2 (OP, DS, & REF BITS)						RESERVED						
	REF (LSB)	REF	REF	REF (MSB)	DS bit	OP bit	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
Bit Value	X	X	X	X	X	X	0	0	0	0	0	0	0
Bit #	25	26	27	28	29	30	31	32	33	34	35	36	37
Example	0	0	0	1	0	0	0	0	0	0	0	0	0

NOTES:
1. "X" INDICATES BIT VALUE CAN BE ONE OR ZERO
2. "0" INDICATES BIT VALUE WILL ALWAYS BE ZERO
3. IN EXAMPLE SHOWN, LED COUNT=59, AGC=1 CA=1, REF=8, DS=0, OP=0.
4. THE WAVEFORM GENERATED AT THE OUTPUT PIN, IN RESPONSE TO A READ REQUEST TO THE CAL/STAT PIN, IS SHOWN BELOW.



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Detailed Description / Application Information

Commands (cont.)

Error Flag

After data is written to a bank of EEPROM, the state machine will compare the content (read out from the same bank) to the data written in. Normally the read data is the same as the write data, but if there is a difference, the Error Flag will be set to "1".

Communication Pins

The CAL/STATUS pin is used to write data to the OPB9000 and the initiate a calibration sequence.

This pin is also used during the STATUS mode to output the status of an attempted calibration. See Calibration section of this data sheet for more information.

The Output pin is used to read the value of all EEPROM bits. See previous section (Commands) for more information.

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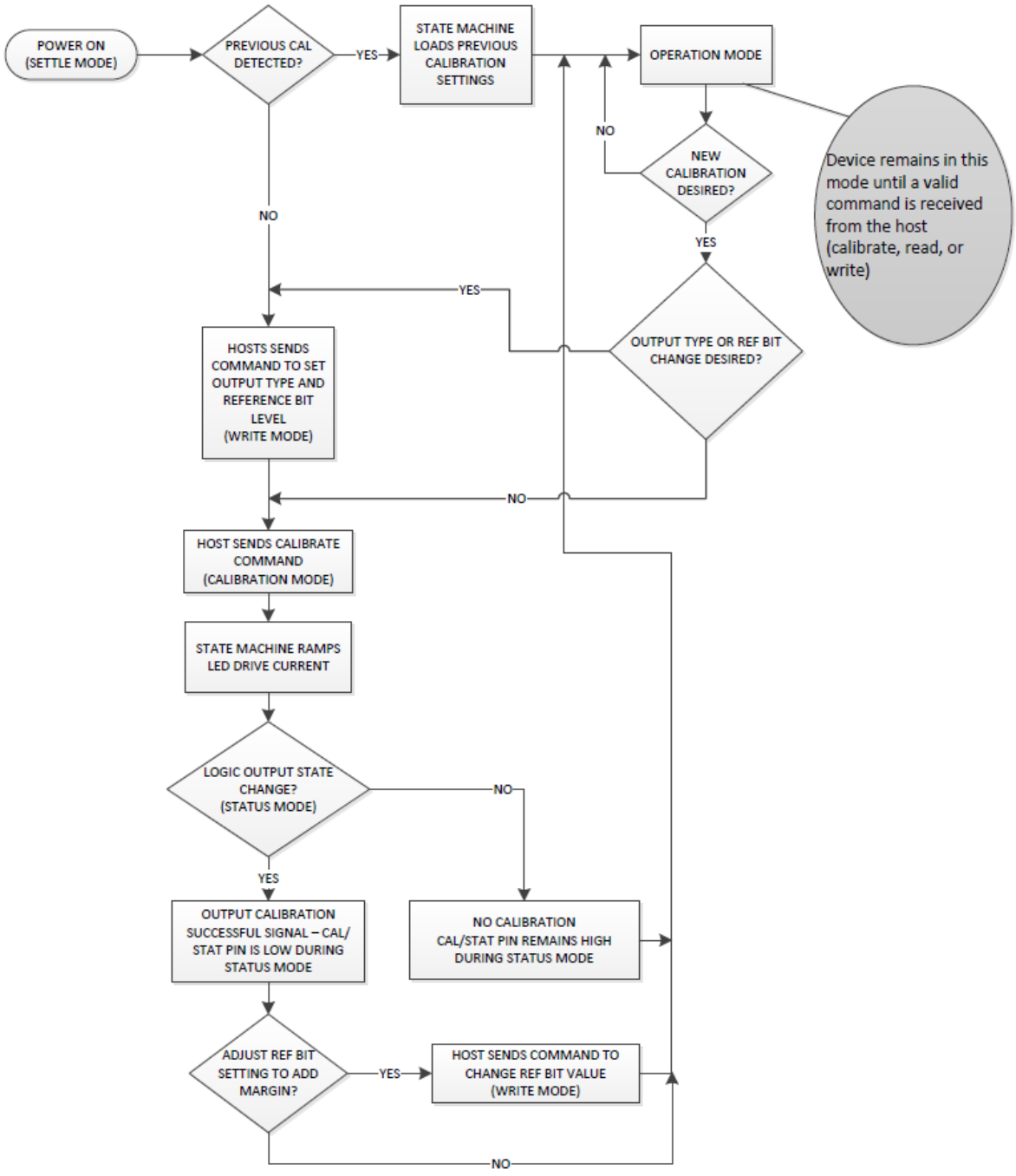
Table 1—Programmable Output Types			
EEPROM BANK2 BIT 5	EEPROM BANK2 BIT 4	DRIVER TYPE	POLARITY
OP (OUTPUT POLARITY)	DS (DRAIN SELECT)		
0	0	Open drain	Buffered
1	0	Open drain	Inverted
0	1	Push-pull	Buffered
1	1	Push-pull	Inverted

Table 2—Programmable Comparator Reference Levels					
REF LEVEL (DECIMAL)	COMP_REF_SEL <3:0>				COMPARISON THRESHOLD DIFFERENTIAL (MV)
	EEPROM BANK2 BIT 3	EEPROM BANK2 BIT 2	EEPROM BANK2 BIT 1	EEPROM BANK2 BIT 0	
0	0	0	0	0	245
1	0	0	0	1	262
2	0	0	1	0	281
3	0	0	1	1	300
4	0	1	0	0	321
5	0	1	0	1	344
6	0	1	1	0	368
7	0	1	1	1	393
8	1	0	0	0	421
9	1	0	0	1	450
10	1	0	1	0	482
11	1	0	1	1	516
12	1	1	0	0	552
13	1	1	0	1	590
14	1	1	1	0	632
15	1	1	1	1	676

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Detailed Description / Application Information - Operational Flow Diagram

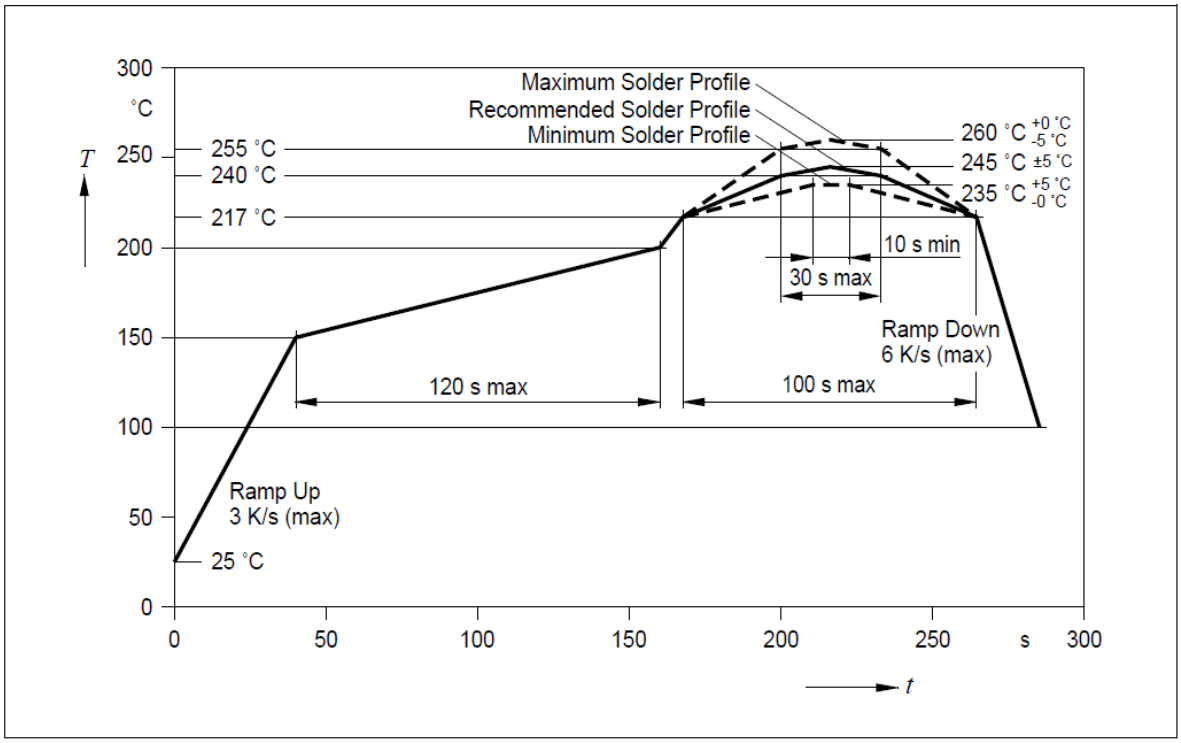


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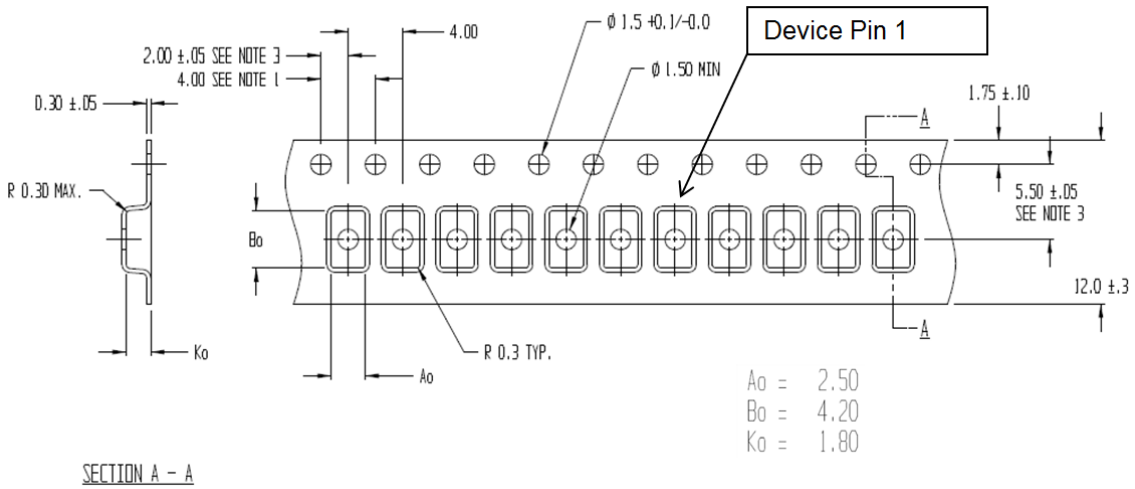
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Solder Profile



Tape and Reel Information (all dimensions in mm)

Loaded quantity per reel—2500 pcs per reel



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